

Result of tenders of RMB Sovereign Bonds held on September 23, 2021

The following is issued on behalf of the Hong Kong Monetary Authority:

Result of the tenders of RMB Sovereign Bonds held on September 23, 2021:

Tender Result

Tender Date : September 23, 2021

Bonds available for Tender : 2-year RMB Bonds

Issue Number : BCMKFB21002

Issue and Settlement Date : September 27, 2021

Maturity Date : September 27, 2023 (or the
closest coupon payment date)

Application Amount : RMB 15,397 million

Issue Amount : RMB 5,000 million

Average accepted Coupon
Rate : 2.27 per cent

Lowest accepted Coupon
Rate : 1.00 per cent

Highest accepted Coupon
Rate : 2.41 per cent
(Bonds' Coupon)

Allocation Ratio : Approximately 86.67 per cent

Tender Date : September 23, 2021

Bonds available for Tender : 5-year RMB Bonds

Issue Number : BCMKFB21003

Issue and Settlement Date : September 27, 2021

Maturity Date : September 27, 2026 (or the
closest coupon payment date)

Application Amount : RMB 6,600 million

Issue Amount : RMB 2,000 million

Average accepted Coupon
Rate : 2.29 per cent

Lowest accepted Coupon
Rate : 1.00 per cent

Highest accepted Coupon
Rate : 2.50 per cent
(Bonds' Coupon)

Allocation Ratio : Approximately 61.35 per cent

Tender Date : September 23, 2021

Bonds available for Tender : 15-year RMB Bonds

Issue Number : BCMKFB16023 (Re-open)

Issue and Settlement Date : September 27, 2021

Maturity Date : December 12, 2031 (or the
closest coupon payment date)

Coupon Rate : 4.15 per cent

Application Amount : RMB 2,560 million

Issue Amount : RMB 1,000 million

Average Accepted Price : 114.11

Lowest Accepted Price : 112.87

Highest Accepted Price : 118.74

Allocation Ratio : Approximately 32.61 per cent